

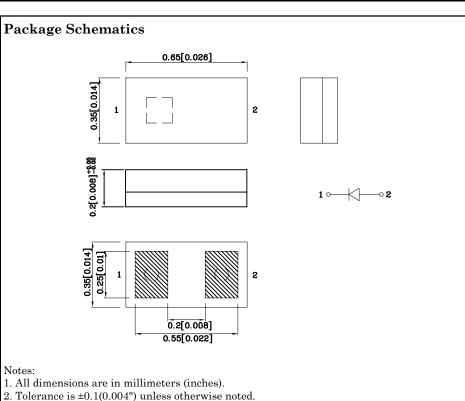
Part Number: XZVGR155W

0.65X0.35mm SMD CHIP LED LAMP (0.2mm Height)

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 4,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 2
- RoHS compliant





- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Green (AlGaInP)	Unit	
Reverse Voltage		5	V	
Forward Current	I_F	20	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA	
Power Dissipation	PD	48	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$	U	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Green (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	1.97	V	
Forward Voltage (Max.) (I _F =10mA)	$V_{\rm F}$	2.4	V	
Reverse Current (Max.) (V _R =5V)	I_{R}	10	uA	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λΡ	572*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	571*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$ riangle\lambda$	20	nm	

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =10mA) mcd		Wavelength CIE127-2007* nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZVGR155W	Green	AlGaInP	Water Clear	6*	14*	572*	135°

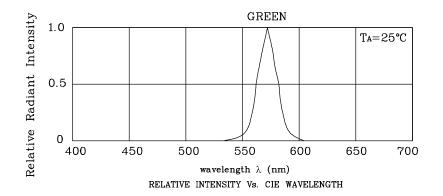
*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

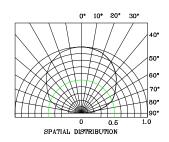
Jan 13,2016

XDSB8229 V3-Z Layout: Maggie L.



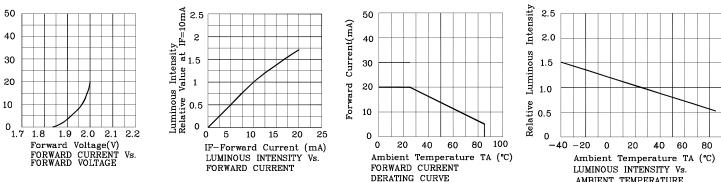
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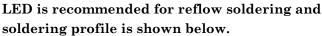


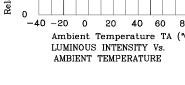


Green

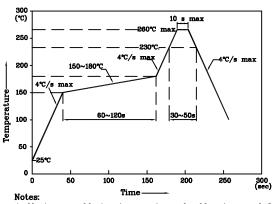
Forward Current(mA)







Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C Do not put stress to the epoxy resin during
- З. high temperatures conditions



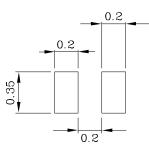
***** The device has a single mounting surface. The device must be mounted according to the specifications.

Recommended Soldering Pattern

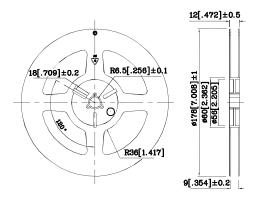
(Units : mm; Tolerance: ± 0.1)

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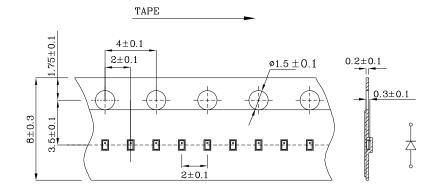
Height)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

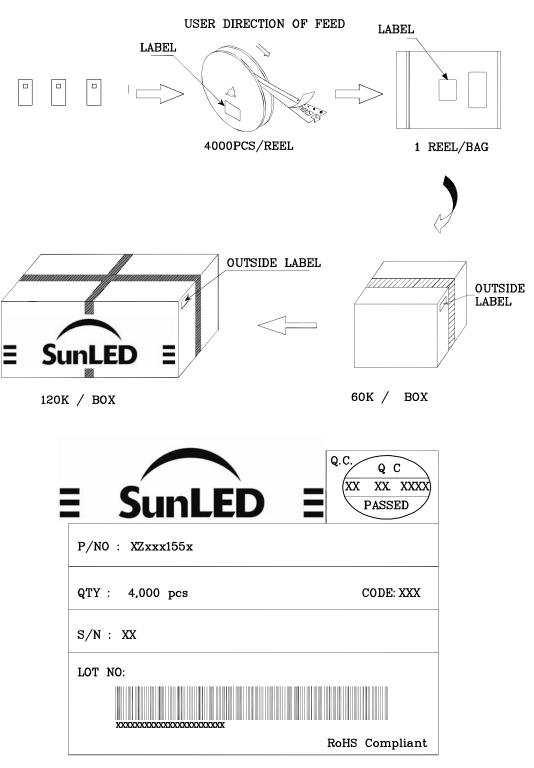
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at <u>http://www.SunLEDusa.com/TechnicalNotes.asp</u>